

December 2013

FCPF7N60NT

N-Channel MOSFET 600 V, 6.8 A, 0.52 Ω

Features

- Typ $R_{DS(on)} = 460 m\Omega$
- Ultra Low Gate Charge (typ. Q_g = 17.8 nC)
- Low Effective Output Capacitance (typ. $C_{oss(eff.)} = 91 pF$)
- 100% Avalanche Tested
- · RoHS Compliant

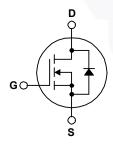
Application

- · Solar Inverter
- AC-DC Power Supply



Description

The SupreMOS® MOSFET is Fairchild Semiconductor's next generation of high voltage super-junction (SJ) technology employing a deep trench filling process that differentiates it from the conventional SJ MOSFETs. This advanced technology and precise process control provides lowest Rsp on-resistance, superior switching performance and ruggedness. SupreMOS MOSFET is suitable for high frequency switching power converter applications such as PFC, server/telecom power, FPD TV power, ATX power, and industrial power applications.



MOSFET Maximum Ratings T_C = 25°C unless otherwise noted.

| Symbol | | Parameter | FCPF7N60NT | Units |
|-----------------------------------|---|---|-------------|-------|
| V _{DSS} | Drain to Source Voltage | 9 | 600 | V |
| V _{GSS} | Gate to Source Voltage | | ±30 | V |
| | Dunin Course | -Continuous (T _C = 25°C) | 6.8* | |
| ID | Drain Current | -Continuous ($T_C = 100^{\circ}C$) | 4.3* | Α |
| I _{DM} | Drain Current | - Pulsed (No | te 1) 20.4 | Α |
| E _{AS} | Single Pulsed Avalanch | ne Energy (No | te 2) 79.4 | mJ |
| I _{AR} | Avalanche Current | anche Current | | Α |
| E _{AR} | Repetitive Avalanche E | nergy | 0.6 | mJ |
| مار راما | MOSFET dv/dt Ruggedness | | 100 | V/ns |
| dv/dt | Peak Diode Recovery of | lv/dt (No | te 3) 4.9 | V/ns |
| Б | Dawar Dissination | $(T_C = 25^{\circ}C)$ | 30.5 | W |
| P_{D} | Power Dissipation | - Derate above 25°C | 0.24 | W/°C |
| T _J , T _{STG} | Operating and Storage | Temperature Range | -55 to +150 | °С |
| T _L | Maximum Lead Temper 1/8" from Case for 5 Se | rature for Soldering Purpose, econds | 300 | °C |

^{*}Drain current limited by maximum junction temperature.

Thermal Characteristics

| Symbol | Parameter | FCPF7N60NT | Units |
|-----------------|--|------------|-------|
| $R_{	heta JC}$ | Thermal Resistance, Junction to Case, Max. | 4.1 | °C/W |
| $R_{\theta JA}$ | Thermal Desistance Junction to Ambient May | | 30/00 |

Package Marking and Ordering Information

| Device Marking | Device | Package | Reel Size | Tape Width | Quantity |
|----------------|------------|---------|-----------|------------|----------|
| FCPF7N60NT | FCPF7N60NT | TO-220F | - | - | 50 |

Electrical Characteristics $T_C = 25^{\circ}C$ unless otherwise noted.

| Symbol | Parameter | Test Conditions | Min. | Тур. | Max. | Units |
|---|--|---|------|------|------|-------|
| Off Charac | cteristics | | | | | |
| BV _{DSS} | Drain to Source Breakdown Voltage | $I_D = 1 \text{mA}, V_{GS} = 0 \text{V}, T_C = 25^{\circ} \text{C}$ | 600 | - | - | V |
| ΔBV _{DSS} / ΔT _J | Breakdown Voltage Temperature Coefficient | I _D = 1mA, Referenced to 25°C | - | 0.6 | - | V/°C |
| | Zero Gate Voltage Drain Current | V _{DS} = 480V, V _{GS} = 0V | - | - | 10 | μА |
| IDSS | Zero Gate voltage Drain Current | $V_{DS} = 480V, V_{GS} = 0V, T_{C} = 125^{\circ}C$ | - | - | 100 | μΑ |
| I _{GSS} | Gate to Body Leakage Current | $V_{GS} = \pm 30V, V_{DS} = 0V$ | - | - | ±100 | nA |

On Characteristics

| V _{GS(th)} | Gate Threshold Voltage | $V_{GS} = V_{DS}$, $I_D = 250\mu A$ | 2.0 | - | 4.0 | V |
|---------------------|--------------------------------------|--------------------------------------|-----|------|------|---|
| R _{DS(on)} | Static Drain to Source On Resistance | $V_{GS} = 10V, I_D = 3.4A$ | - | 0.46 | 0.52 | Ω |
| 9 _{FS} | Forward Transconductance | $V_{DS} = 20V, I_{D} = 3.4A$ | - | 8.5 | 1 | S |

Dynamic Characteristics

| C _{iss} | Input Capacitance | V 400V V 0V | - | 719 | 960 | pF |
|----------------------|------------------------------------|--|-----|------|------|----|
| Coss | Output Capacitance | $V_{DS} = 100V, V_{GS} = 0V$ f = 1MHz | | 30 | 40 | pF |
| C _{rss} | Reverse Transfer Capacitance | 1 - 1101112 | - | 2.1 | 3.2 | pF |
| C _{oss} | Output Capacitance | $V_{DS} = 380V, V_{GS} = 0V, f = 1MHz$ | - \ | 17 | - | pF |
| C _{oss} eff | Effective Output Capacitance | V_{DS} = 0V to 380V, V_{GS} = 0V | - | 91 | - | pF |
| Q _{g(tot)} | Total Gate Charge at 10V | $V_{DS} = 380V, I_{D} = 3.4A$ | - | 17.8 | 35.6 | nC |
| Q_{gs} | Gate to Source Gate Charge | V _{GS} = 10V | - | 3.2 | 6.3 | nC |
| Q_{gd} | Gate to Drain "Miller" Charge | (Note 4) | - | 6.0 | 11.9 | nC |
| ESR | Equivalent Series Resistance (G-S) | Drain Open | - | 2.5 | - | Ω |

Switching Characteristics

| t _{d(on)} | Turn-On Delay Time | | - / | 12 | 24 | ns |
|---------------------|---------------------|-----------------------------|-----|----|----|----|
| t _r | Turn-On Rise Time | $V_{DD} = 380V, I_D = 3.4A$ | -/ | 6 | 22 | ns |
| t _{d(off)} | Turn-Off Delay Time | $R_G = 4.7\Omega$ | - | 35 | 80 | ns |
| t _f | Turn-Off Fall Time | (Note 4) | 7/- | 12 | 24 | ns |

Drain-Source Diode Characteristics

| I _S | Maximum Continuous Drain to Source Diode Forward Current | | | - | 6.8 | Α |
|-----------------|--|--|---|-----|------|----|
| I _{SM} | Maximum Pulsed Drain to Source Diode Forward Current | | | - | 20.4 | Α |
| V_{SD} | Drain to Source Diode Forward Voltage | V _{GS} = 0V, I _{SD} =3.4A | - | > | 1.2 | V |
| t _{rr} | Reverse Recovery Time | V _{GS} = 0V, I _{SD} = 3.4A | - | 211 | - | ns |
| Q _{rr} | Reverse Recovery Charge | $dI_F/dt = 100A/\mu s$ | - | 1.8 | - | μC |

Notes

- 1. Repetitive rating: pulse-width limited by maximum junction temperature.
- 2. I_{AS} = 12A, V_{DD} = 50V, R_G = 25 Ω , starting T_J = 25 $^{\circ}$ C.
- 3. I $_{SD} \leq$ 36A, di/dt \leq 200A/µs, V $_{DD}$ = 380V starting T $_{J}$ = 25°C.
- 4. Essentially independent of operating temperature.

Typical Characteristics

1.0

Drain-Source On-Resistance

0.2

 $R_{DS(ON)}$ [Ω],

Figure 1. On-Region Characteristics

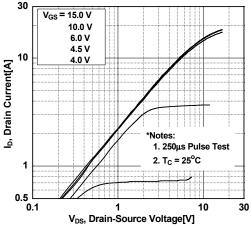


Figure 3. On-Resistance Variation vs.
Drain Current and Gate Voltage



Figure 5. Capacitance Characteristics

ID, Drain Current [A]

V_{GS} = 10V

V_{GS} = 20V

12

*Note: T_C = 25°C

16

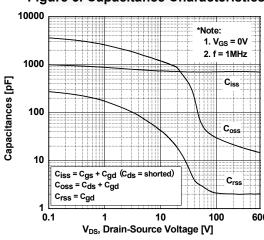


Figure 2. Transfer Characteristics

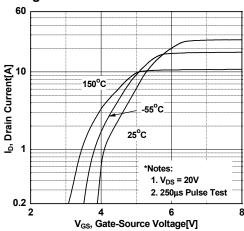


Figure 4. Body Diode Forward Voltage Variation vs. Source Current and Temperature

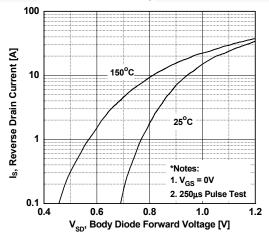
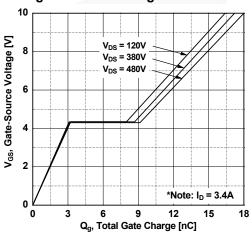


Figure 6. Gate Charge Characteristics



Typical Characteristics (Continued)

Figure 7. Breakdown Voltage Variation vs. Temperature

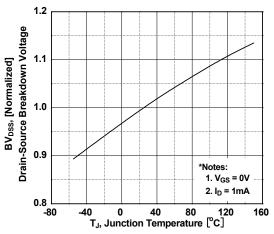


Figure 9. Maximum Safe Operating Area _ FCPF7N60NT

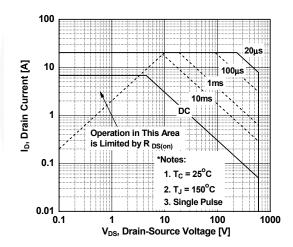


Figure 8. On-Resistance Variation vs. Temperature

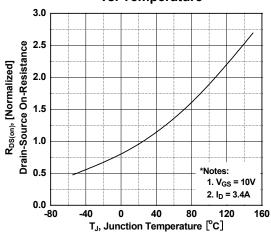
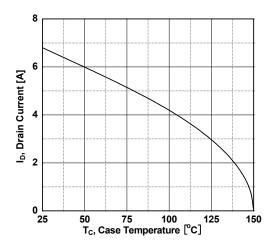


Figure 10. Maximum Drain Current vs. Case Temperature



Typical Characteristics (Continued)

Figure 11. Transient Thermal Response Curve

_ FCPF7N60NT

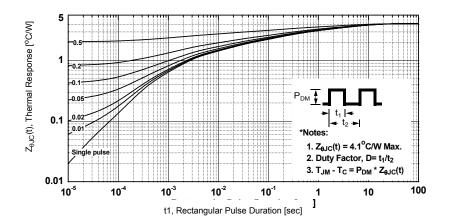


Figure 12. Gate Charge Test Circuit & Waveform

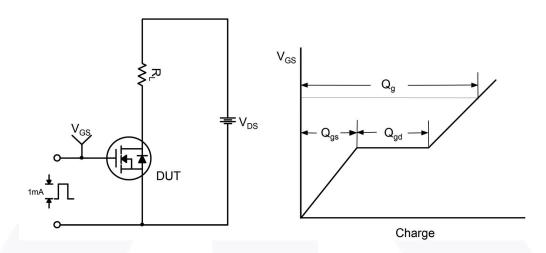


Figure 13. Resistive Switching Test Circuit & Waveforms

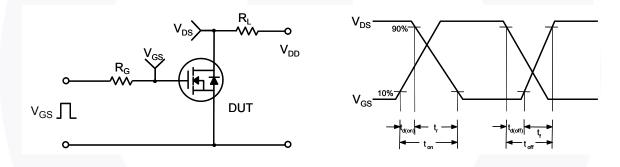
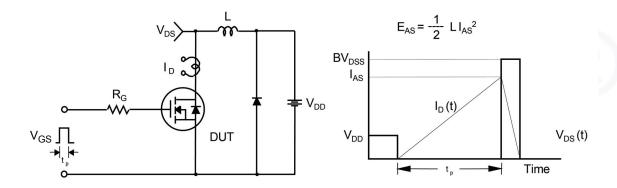


Figure 14. Unclamped Inductive Switching Test Circuit & Waveforms



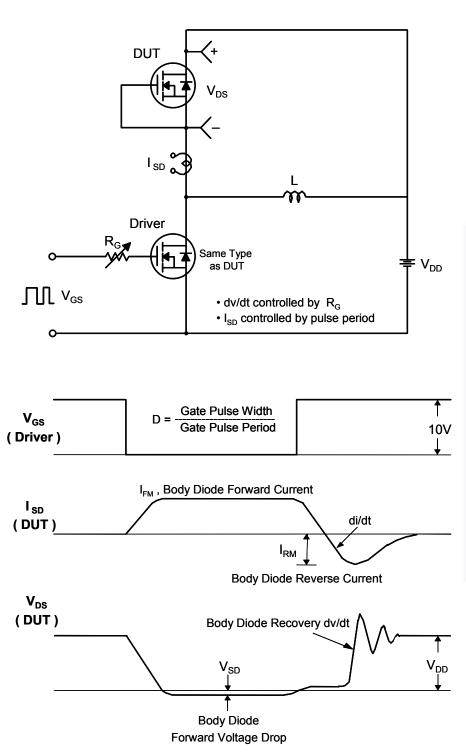


Figure 15. Peak Diode Recovery dv/dt Test Circuit & Waveforms

Mechanical Dimensions

TO-220F 3L

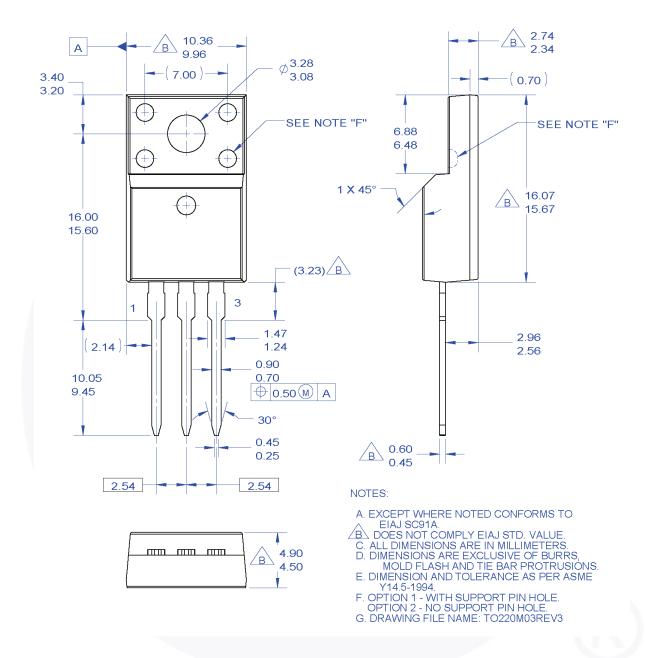


Figure 16. TO220, Molded, 3LD, Full Pack, EIAJ SC91, Straight Lead

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